



#### MDP14012K70GE04 Information



For Reference Only

Part Number MDP14012K70GE04

Manufacturer Vishay Dale Category Resistors

Resistor Networks, Arrays

**Description** RES ARRAY 13 RES 2.7K OHM 14DIP

**Package** 14-DIP (0.300", 7.62mm)

For the pricing/inventory/lead time, please contact

us

Website: https://www.heisener.com E-mail: salesdept@heisener.com



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# MDP14012K70GE04 Specifications

Manufacturer Part Number         MDP14012K70GE04           Manufacturer         Vishay Dale           Category         Resistors           Resistor Networks, Arrays           Package         14-DIP (0.300", 7.62mm)           Series         MDP           Circuit Type         Bussed           Resistance (Ohms)         2.7k           Tolerance         ±2%           Number of Resistors         13           Number of Pins         14           Power Per Element         125mW           Temperature Coefficient         ±100ppm/°C           Operating Temperature         -55°C ~ 125°C           Applications         -           Mounting Type         Through Hole           Package / Case         14-DIP (0.300", 7.62mm)           Supplier Device Package         14-DIP           Size / Dimension         0.750" L x 0.250" W (19.05mm x 6.35mm)           Height - Seated (Max)         0.155" (3.94mm)		
Category         Resistors           Resistor Networks, Arrays           Package         14-DIP (0.300", 7.62mm)           Series         MDP           Circuit Type         Bussed           Resistance (Ohms)         2.7k           Tolerance         ±2%           Number of Resistors         13           Number of Pins         14           Power Per Element         125mW           Temperature Coefficient         ±100ppm/°C           Operating Temperature         -55°C ~ 125°C           Applications         -           Mounting Type         Through Hole           Package / Case         14-DIP (0.300", 7.62mm)           Supplier Device Package         14-DIP           Size / Dimension         0.750" L x 0.250" W (19.05mm x 6.35mm)           Height - Seated (Max)         0.155" (3.94mm)	Manufacturer Part Number	MDP14012K70GE04
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Tolerance       ±2%         Number of Resistors       13         Number of Pins       14         Power Per Element       125mW         Temperature Coefficient       ±100ppm/°C         Operating Temperature       -55°C ~ 125°C         Applications       -         Mounting Type       Through Hole         Package / Case       14-DIP (0.300", 7.62mm)         Supplier Device Package       14-DIP         Size / Dimension       0.750" L x 0.250" W (19.05mm x 6.35mm)         Height - Seated (Max)       0.155" (3.94mm)	Circuit Type	Bussed
Number of Resistors  13  Number of Pins  14  Power Per Element  125mW  Temperature Coefficient  55°C ~ 125°C  Applications  -  Mounting Type  Through Hole  Package / Case  14-DIP (0.300", 7.62mm)  Size / Dimension  0.750" L x 0.250" W (19.05mm x 6.35mm)  Height - Seated (Max)  14  14  15  16  17  18  18  19  19  10  10  10  10  10  10  10  10	Resistance (Ohms)	2.7k
Number of Pins  14  Power Per Element  125mW  Temperature Coefficient  ±100ppm/°C  Operating Temperature  -55°C ~ 125°C  Applications  -  Mounting Type  Through Hole  Package / Case  14-DIP (0.300", 7.62mm)  Supplier Device Package  14-DIP  Size / Dimension  0.750" L x 0.250" W (19.05mm x 6.35mm)  Height - Seated (Max)  0.155" (3.94mm)	Tolerance	±2%
Power Per Element  125mW  Temperature Coefficient  ±100ppm/°C  Operating Temperature  -55°C ~ 125°C  Applications  -  Mounting Type  Through Hole  Package / Case  14-DIP (0.300", 7.62mm)  Supplier Device Package  14-DIP  Size / Dimension  0.750" L x 0.250" W (19.05mm x 6.35mm)  Height - Seated (Max)  0.155" (3.94mm)	Number of Resistors	13
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Height - Seated (Max) 0.155" (3.94mm)	Supplier Device Package	14-DIP
	Size / Dimension	0.750" L x 0.250" W (19.05mm x 6.35mm)
Report errors?	Height - Seated (Max)	0.155" (3.94mm)
		Report errors?

#### MDP14012K70GE04 Guarantees



#### **Quality Guarantees**

We provide 90 days warranty. \*

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



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We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

### MDP14012K70GE04 Payment Methods



















## MDP14012K70GE04 Shipping Methods













If you have any question about MDP14012K70GE04, please do not hesitate to contact us!

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